

S/N 09/854,539



**PATENT**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Steven Towle Examiner: Unknown  
Serial No.: 09/854,539 Group Art Unit: 3729  
Filed: May 14, 2001 Docket: 884.415US1  
Title: POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR  
USE IN MICROELECTRONIC CIRCUIT PACKAGING

## **COMMUNICATION RE: INCORRECT FILING RECEIPT**

Commissioner for Patents  
Washington, D.C. 20231

Applicants hereby request correction of the Filing Receipt with respect to the above-identified patent application. In the Filing Receipt received July 17, 2001, (copy enclosed), the Title is incorrect. The Filing Receipt reads: *Polymeric Encapsulation Material with Fibrous Filler for use in Microelectric Circuit Packaging*. The Filing receipt should read: *Polymeric Encapsulation Material with Fibrous Filler for use in Microelectronic Circuit Packaging*. This is evidenced by the first page of the application (copy enclosed).

Applicant would appreciate the above-identified printing error be corrected and that a new "corrected" filing receipt be sent to Applicant's representatives at the address given below.

Respectfully submitted,

STEVEN TOWLE

By his Representatives.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
P.O. Box 2938  
Minneapolis, MN 55402  
(612) 349-9592

Date July 24, 2001

By Ann M. McCrackin  
Ann M. McCrackin

Ann M. McCrackin  
Reg. No. 42,858  
AMM:CMG:clh

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Assistant Commissioner of Patents, Washington, D.C. 20231, on July 24, 2001.

**Date of Deposit**

ANN McCRAE/N

Ann M. McCracken



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS  
UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231  
www.uspto.gov

APPLICATION NUMBER	FILING DATE	GRP/ART UNIT	FIL FEE REC'D	ATTY/DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/854,539	05/14/2001	3729	782	884.415US1	6	24	3

CONFIRMATION NO. 8328

## FILING RECEIPT



\*0C001000006282394\*

Schwegman, Lunberg, Woessner & Kluth, P.A.  
P.O. Box 2938  
Minneapolis, MN 55402

Date Mailed: 07/11/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Steven Towle, Phoenix, AZ

## Assignment For Published Patent Application

Intel Corporation

D 14 MAY 2002 CONN. EXP.

## Domestic Priority data as claimed by applicant

## Foreign Applications

If Required, Foreign Filing License Granted 07/10/2001

Projected Publication Date: 11/14/2002

Schwegman, Lunberg  
Woessner & Kluth, P.A.

Non-Publication Request: No

JUL 17 2001

Early Publication Request: No

RECEIVED

## Title

Polymeric encapsulation material with fibrous filler for use in microelectric circuit packaging

## Preliminary Class

029

UNITED STATES PATENT APPLICATION

**POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR USE IN  
MICROELECTRONIC CIRCUIT PACKAGING**

**INVENTOR**

**Steven Towle**

Schwegman, Lundberg, Woessner & Kluth, P.A.  
1600 TCF Tower  
121 South Eighth Street  
Minneapolis, MN 55402  
ATTORNEY DOCKET SLWK 884.415US1US1  
Client Ref. No. P10931



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Steven Towle

Title: POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR USE IN  
MICROELECTRONIC CIRCUIT PACKAGING

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Filed: May 14, 2001

Due Date: N/A

Examiner: Unknown

Group Art Unit: 3729

Commissioner for Patents  
Washington, D.C. 20231

We are transmitting herewith the attached:

- Communication Re: Incorrect Filing Receipt (1 pg.)
- Copy of Filing Receipt (1 pg.)
- A return postcard.
- Copy of the First Page of the Application (1 pg.)

No Additional fee is required.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
P.O. Box 2938, Minneapolis, MN 55402 (612-373-6900)

By: Ann M. McCrackin  
Name: Ann M. McCrackin  
Reg. No. 42,858  
AMM:CMG:clh

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this 24 day of July, 2001.

ANN McCRAKIN  
Name

Ann M. McCrackin  
Signature